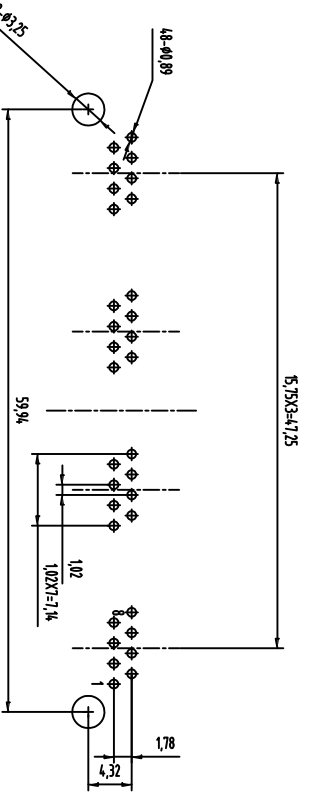
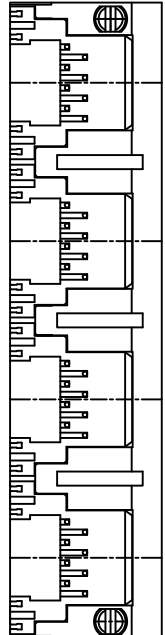
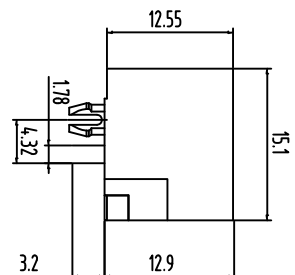
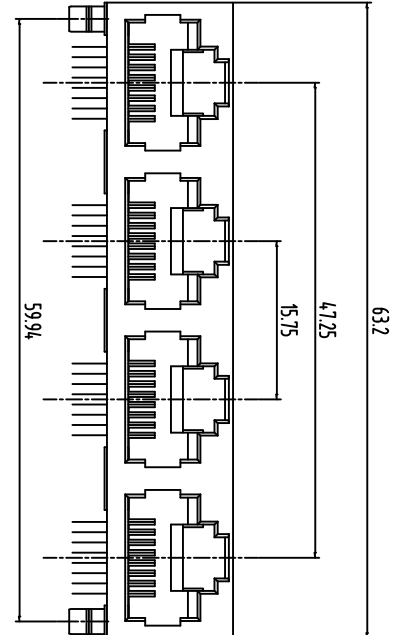


Rev	AWO #	Description	Date	Appr
-		RELEASED	12/08/10	

APPROVED: _____
 DATE: _____ TITLE: _____



PC Board Layout

X	PLATING
0	15 μ in Gold
1	30 μ in Gold
2	50 μ in Gold

SPECIFICATIONS:

Material: Insulator: PA66, rated UL 94V-0
 Insulator color: Black
 Contacts: Phosphor Bronze
 Contact Plating:
 Gold Flash over Nickel underplate on contact area,
 Tin over Copper underplate on tails
 (See chart for thickness).
 Electrical:
 Operating voltage: 125 VAC max
 Current rating: 1.5 Amps max
 Contact Resistance: 30 mohms max. initial
 Insulation resistance: 500 Mohms min @ 500 VDC
 Dielectric withstanding voltage: 1000 VAC for 1 minut
 Temperature Rating:
 Operating temperature: -40°C to +70°C
 Environmental:
 Lead free, RoHS compliant.
 Recommended soldering temp: 235°C for 5 sec.

ADAM TECH

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 Phone: 908-687-5000 Fax: 908-687-5710

MODULAR TELEPHONE JACK, GANGED 8P8C, R/A

UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE INCHES [MM]	
TOLERANCES: EXCEPT AS NOTED	
INCHES	HOLES
.X ±.10	Ø.X ±.10
.XX ±.020	Ø.XX ±.015
.XXX ±.015	Ø.XXX ±.010
APPROVALS	DATE
DRAWN	DY
CHECKED	12/08/10
APPROVED	

TITLE	SIZE	PART NO.	REV.
MODULAR TELEPHONE JACK, GANGED 8P8C, R/A	X	MTJG-4-88ARX1	
REF: 500167T	SCALE: NTS	SHEET 1 OF 1	